

3.2x1.25 x1.1mm Reverse Mount Red & Yellow Green Chip LED

OSRG1205C1N

■Features

- Bi-Color
- Super high brightness of reverse mount LED
- Compact package outline (L x W x T) of 3.2mm x 1.25mm x 1.1mm
- Compatible to IR reflow soldering.
- Water Clear Type

Applications

Backlighting (switches, keys, etc.)

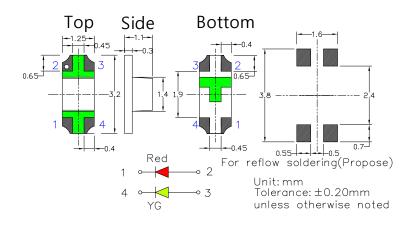
■Absolute Maximum Rating

Marker lights (e.g. steps, exit ways, etc.)

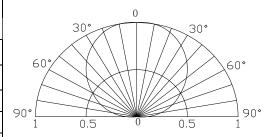
(Ta=25°C)

Value Symbol Item Unit YG R DC Forward Current 20 20 mA Pulse Forward Current# 100 100 I_{FP} mA Reverse Voltage V_R 5 5 V Power Dissipation 43 46 mW $P_{\text{D}} \\$ **-40** ~ +85 $^{\circ}$ C Operating Temperature Topr $^{\circ}$ C Storage Temperature Tstg **-40**∼ +85 Lead Soldering Temperature 260°C/5sec Tsol

■Outline Dimension



Directivity



#Pulse width Max 0.1ms, Duty ratio max 1/10

■Electrical -Optical Characteristics

(Ta=25°C)

	Color		$V_{F}(V)$			$I_R(\mu A)$	Iv(mcd)			λD(nm)			2θ1/2(deg)
Part Number			Min.	Тур.	Max.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Тур.
			I _F =5mA			V _R =5V	I _F =5mA						
OSRG1205C1N	Red		-	1.7	2.3	10	30	50	-	620	625	630	120
	Yellow Green		-	1.7	2.3	10	10	15	-	565	570	575	120

^{*1} Tolerance of measurements of dominant wavelength is ±1nm

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^{*2} Tolerance of measurements of luminous intensity is ±15%

^{*3} Tolerance of measurements of forward voltage is±0.1V



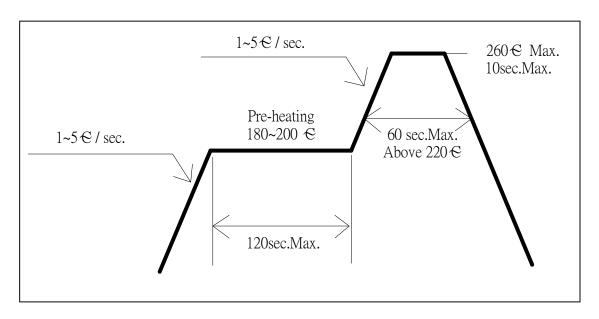
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■ Soldering Conditions

	Reflow Soldering	Hand Soldering			
Pre-Heat	180 ∼ 200°C				
Pre-Heat Time	120 sec. Max.				
Peak temperature	260°C Max.	Temperature	350°C Max. 3 sec. Max.		
Dipping Time	10 sec. Max.	Soldering time			
Condition	Refer to Temperature-profile		(one time only)		

• Reflow Soldering Condition(Lead-free Solder)



- *Recommended soldering conditions vary according to the type of LED
- *Although the recommended soldering conditions are specified in the above table, reflow, or hand soldering at the lowest possible temperature is desirable for the LEDs.
- *A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- •All SMD LED products are pb-free soldering available.
- Occasionally there is a brightness decrease caused by the influence of heat or ambient atmosphere during air reflow. It is recommended that the User use the nitrogen reflow method.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.

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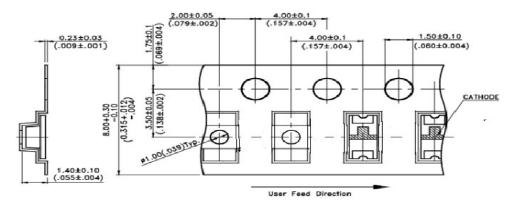


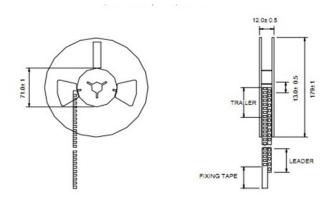
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■ Reel & Tape Dimensions

- 1. Quantity:3000pcs/Reel
- 2. Note: The tolerances unless mentioned is ± 0.1 mm, Unit:mm





■ Cautions:

- 1. After open the package, the LED´s floor life is 4 Weeks under 30℃ or less and 60%RH or less(MSL:2a).
- 2. Heat generation must be taken into design consideration when using the LED.
- 3. Power must be applied resistors for protection, over current would be caused the optic damage to the devices and wavelength shift.
- 4. Manual tip solder may cause the damage to Chip devices, so advised that heat of iron should be lower than 15W with temperature control under 5 seconds at 230-260 deg. C. (The device would be got damage in re working process, recommended under 5 seconds at 230-260 deg. C)
- 5. All equipment and machinery must be properly grounded. It is recommended to use a wristband or anti-electrostatic glove when handing the LED.
- 6. Use IPA as a solvent for cleaning the LED. The other solvent may dissolve the LED package and the epoxy, Ultrasonic cleaning should not be done.
- 7. Damaged LED will show unusual characteristics such as leak current remarkably increase, turn-on voltage becomes lower and the LED get unlight at low current.

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